

INITIAL PRODUCT/PROCESS CHANGE NOTIFICATION Generic Copy

25 Sep 2008

SUBJECT: ON Semiconductor Initial Product/Process Change Notification #16152

TITLE: PTC Products (former ADI Parts) MSOP8_10 Carsem to Seremban Assembly transfer

PROPOSED FIRST SHIP DATE: 25 Jan 2009

AFFECTED CHANGE CATEGORY: Assembly Site

AFFECTED PRODUCT DIVISION: Power Switching Devices (PQ)

FOR ANY OUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local ON Semiconductor Sales Office or Wyler Montoya wyler.Montoya@onsemi.com>

NOTIFICATION TYPE:

Initial Product/Process Change Notification (IPCN)

First change notification sent to customers. IPCNs are issued at least 120 days prior to implementation of the change. An IPCN is advance notification about an upcoming change and contains general information regarding the change details and devices affected. It also contains the preliminary reliability qualification plan.

The completed qualification and characterization data will be included in the Final Product/Process Change Notification (FPCN).

This IPCN notification will be followed by a Final Product/Process Change Notification (FPCN) at least 90 days prior to implementation of the change.

DESCRIPTION AND PURPOSE:

The purpose of this Initial PCN is to notify customers of ON Semiconductor's plan to qualify and transfer production of the Power Switching devices build on MSOP8 and 10 packages from Carsem (Malaysia) to ON Semiconductor's Assembly facility in Seremban (Malaysia).

The BOM and electrical specifications will remain identical. A full electrical characterization over temperature will be performed for each qualification vehicle to ensure device functionality and electrical specifications.

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QUALIFICATION PLAN:

Qual Vehicles

- ADP3611 MSOP-8
- ADT7461 MSOP-10

Reliability Tests (for each qual vehicle)

- SAT (MSL 1 & MSL 3) 3 assembly lots, 5 units/lot, MSL assessment to define the MSL level before reliability tests 12 days (include Pre/Post CSAM analysis)
- PC(MSL 1)-AC 96hrs, 3 assembly lots, 80 units/lot 15 days
- PC(MSL 1)-TC 500cycs, 3 assembly lots, 80 units/lot 27 days
- PC(MSL 1)-HAST 96hrs, 3 assembly lots, 80 units/lot 15 days
- If MSL 3 deduct 5 days for each tests

Critical Path - SAT then PC-TC 500cycs

- For MSL 1 12 days + 27 days = 39 days
- For MSL 3-7 days + 22 days = 29 days
- Tri-temp. electrical characterization 1 lot, 30 units/lot

Assembly Related tests (for each qual vehicle)

- BPS 1 lot, 30 bonds from 5 units
- BS 1 lot, 30 bonds from 5 units
- RSH 1 lot, 30 units
- PD 1 lot, 30 units

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AFFECTED DEVICE LIST:

PART

AD51-057Z-000

AD51-057Z-0REEL

AD51-057Z-0REEL7

AD51-067ARMZ-2RL

AD51-067ARMZ-R

ADM1032ARMZ

ADM1032ARMZ-001

ADM1032ARMZ-002

ADM1032ARMZ-1RL

ADM1032ARMZ-2R

ADM1032ARMZ-2RL7

ADM1032ARMZ-R7

ADM1032ARMZ-REEL

ADT7421ARMZ-2RL

ADT7421ARMZ-2RL7

ADT7421ARMZ-REEL

ADT7421ARMZ-RL7

ADT7431 (Root Part Number)

ADT7461A0001RMZR

ADT7461A0002RMZR

ADT7461AARMZ

ADT7461AARMZ-002

ADT7461AARMZ-2RL

ADT7461AARMZ2RL7

ADT7461AARMZ-R

ADT7461AARMZ-RL7

ADT7461ARM

ADT7461ARM-REEL

ADT7461ARM-REEL7

ADT7461ARMZ

ADT7461ARMZ-002

ADT7461ARMZ-2R

ADT7461ARMZ-2RL7

ADT7461ARMZ-R7

ADT7481 (Root Part Number)

ADT7482 (Root Part Number)

ADT7484 (Root Part Number)

ADT7484A (Root Part Number)

ADT7485A (Root Part Number)

ADT7486A (Root Part Number)

ADT7488A (Root Part Number)

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